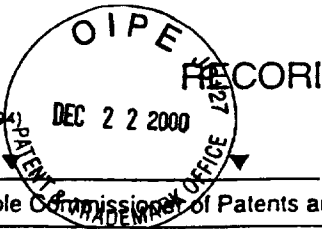


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12-29-2000



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1. Name of conveying party(ies):

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Additional name(s) of conveying party(ies) attached? ☒ Yes ☐ No

3. Nature of conveyance:

☒ Assignment

☐ Merger

☐ Security Agreement

☐ Change of Name

☐ Other

Execution Date: See attached sheet

2. Name and address of receiving party(ies)

Name: Hitachi, Ltd.

Internal Address:

Street Address: 6, Kanda Surugadai 4-chome

Chiyoda-ku

City: Tokyo, Japan

State:

ZIP:

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s): Serial No. 09/654,612

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)

12/27/2000 ETULU1 00000027 09654612

02 FC:581

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B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Gregory E. Montone, Esq.

Internal Address: ANTONELLI, TERRY, STOUT
& KRAUS, LLP

Street Address: 1300 N. Seventeenth Street

Suite 1800

City: Arlington State: VA ZIP: 22209

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41).....\$ 40.00

☒ Enclosed

☒ Any shortage

☐ Authorized to be charged to deposit account

8. Deposit account number:

01-2135

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Gregory E. Montone

Name of Person Signing

Reg. No. 28,141

Signature

December 22, 2000

Date

3

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Commissioner of Patents & Trademarks, Box Assignments
Washington D.C. 20231

PATENT
REEL: 011368 FRAME: 0053

INVENTORS' NAMES AND DATES OF EXECUTION OF ASSIGNMENT

<u>NAMES</u>	<u>DATE ASSIGNMENT EXECUTED</u>
Ryuji Kohno	August 21, 2000
Hiroya Shimizu	August 22, 2000
Masatoshi Kanamaru	August 22, 2000
Aysushi Hosogane	August 23, 2000
Toshio Miyatake	August 22, 2000
Hideo Miura	August 23, 2000
Tatsuya Nagata	August 23, 2000
Yoshishige Endo	August 22, 2000
Masaaki Namba	August 31, 2000
Yuji Wada	August 28, 2000

ASSIGNMENT
(譲 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI, LTD., a corporation organized under the laws of Japan, located at 6, Kanda Surugadai 4-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

"METHOD FOR PRODUCING SEMICONDUCTOR DEVICE AND APPARATUS
USABLE THEREIN"

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI, LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI, LTD.

Signed on the date(s) indicated aside signatures:

INVENTOR(S)

(発明者フルネームサイン)

Date Signed

(署名日)

1)	<u>Ryuzo Kohno</u>	<u>Aug. 21, 2000</u>
2)	<u>Hiroya Shimizu</u>	<u>Aug. 22, 2000</u>
3)	<u>Masatoshi Hanamaru</u>	<u>Aug. 22, 2000</u>
4)	<u>Atsushi Horogane</u>	<u>Aug. 23, 2000</u>
5)	<u>Toshio Miyatake</u>	<u>Aug. 22, 2000</u>
6)	<u>Hideo Ohma</u>	<u>Aug. 23, 2000</u>
7)	<u>Tatsuya Nagata</u>	<u>Aug. 23, 2000</u>
8)	<u>Ushiohisa Enda</u>	<u>Aug. 22, 2000</u>
9)	<u>Masaaki Namba</u>	<u>Aug. 31, 2000</u>
10)	<u>Yuji Wada</u>	<u>Aug. 28, 2000</u>